

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Gate leakage current	I_{GSS}	$V_{GS} = +20\text{ V}, V_{DS} = 0\text{ V}$	□	□	4	nA
Drain cut-OFF current	I_{DSS}	$V_{GS} = 30\text{ V}, V_{DS} = 0\text{ V}$	□	□	10	μA
Drain-source breakdown voltage	$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	30	□	□	V
	$V_{(BR)DSC}$	$I_D = 10\text{ mA}, V_{GS} = -20\text{ V}$	10	□	□	V
Gate threshold voltage	V_{th}	$V_{GS} = 10\text{ V}, I_D = 1\text{ mA}$	1.3	□	2.5	V
Drain-source ON resistance	$R_{DS(ON)}$	$V_{GS} = 4.5\text{ V}, I_D = 6.5\text{ A}$	□	7.5	10	mΩ
		$V_{GS} = 10\text{ V}, I_D = 6.5\text{ A}$	□	5.1	6.6	mΩ
Forward transfer admittance	$ Y_{fs} $	$V_{GS} = 10\text{ V}, I_D = 6.5\text{ A}$	15	30	□	S
Input capacitance	C_{iss}		□	1800	□	pF
Reverse transfer capacitance	C_{rss}	$V_{GS} = 10\text{ V}, V_{DS} = 0\text{ V}, f = 1\text{ MHz}$	□	370	□	pF
Output capacitance	C_{oss}		□	570	□	pF
Switching time	Rise time	t_r	□	15	□	ns
	Turn-ON time	t_{on}	□	28	□	ns
	Fall time	t_f	□	21	□	ns
	Turn-OFF time	t_{off}	□	54	□	ns
Total gate charge (gate-source plus gate-drain)	Q_g		□	42	□	nC
Gate-source charge 1	Q_{gs1}	$V_{GS} = -24\text{ V}, V_{DS} = 10\text{ V}, I_D = 13\text{ A}$	□	6.5	□	nC
Gate-drain (Miller) charge	Q_{gd}		□	14	□	nC

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Drain reverse current	I_{DREV} (Note 1)		□	□	52	A
Forward voltage (diode)	V_{GSF}	$I_{DR} = 13\text{ A}, V_{DS} = 0\text{ V}$	□	□	-1.2	V



